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- Max  $r_{DS(on)} = 2.4 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Max  $r_{DS(on)} = 3.0 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 23 \text{ A}$
- Advanced package and silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

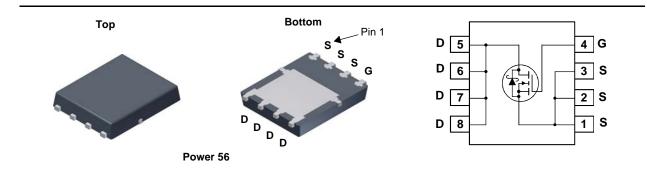


## **General Description**

The FDMS8023S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic Schottky body diode.

## **Applications**

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25°C		49		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25°C		128		
ID	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	26	Α	
	-Pulsed			100		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	86	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		59	14/	
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Ra	ange		-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.1	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	l) 50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8023S	FDMS8023S	Power 56	13 "	12 mm	3000 units

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October 2014

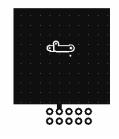
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25°C		16		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			500	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25°C		-5		mV/°C	
	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 26 A		2.0	2.4		
r <sub>DS(on)</sub>		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 23 A		2.6	3.0	mΩ	
		$V_{GS} = 10 V, I_D = 26 A, T_J = 125^{\circ}C$		2.7	3.3	]	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 26 A		168		S	
•	Characteristics			2670	2550	~ [	
C <sub>iss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V,		2670 975	3550 1300	pF	
C <sub>oss</sub>	Reverse Transfer Capacitance	f = 1MHz		975	1300	pF pF	
C <sub>rss</sub> R <sub>q</sub>	Gate Resistance			93 0.7	2.5	Ω	
0				0.7	2.0	32	
-	g Characteristics			12	21		
t <sub>d(on)</sub>	Turn-On Delay Time Rise Time			5	10	ns ns	
t <sub>r</sub>	Turn-Off Delay Time	$V_{DD}$ = 15 V, I <sub>D</sub> = 26 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		32	52	ns	
t <sub>d(off)</sub> t <sub>f</sub>	Fall Time	1 GS = 10 1, 1 GEN = 0 12		4	10	ns	
u Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		41	57	nC	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		20	28	nC	
Q <sub>gs</sub>	Gate to Source Charge	$I_{\rm D} = 26 \text{ A}$		7.0	20	nC	
<u>∽gs</u> Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.4		nC	
*		<u> </u>			<u>I</u>		
	urce Diode Characteristics	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.63	0.8		
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 26 A$ (Note 2)		0.05	1.2	V	
		165 - 0 1, 15 - 20 A (11010 Z)		0.0		1	

$Q_{rr}$
Notes

t<sub>rr</sub>

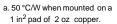
Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

 $I_F = 26$  A, di/dt = 300 A/µs



Reverse Recovery Time

Reverse Recovery Charge





b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

29

32

46

51

ns

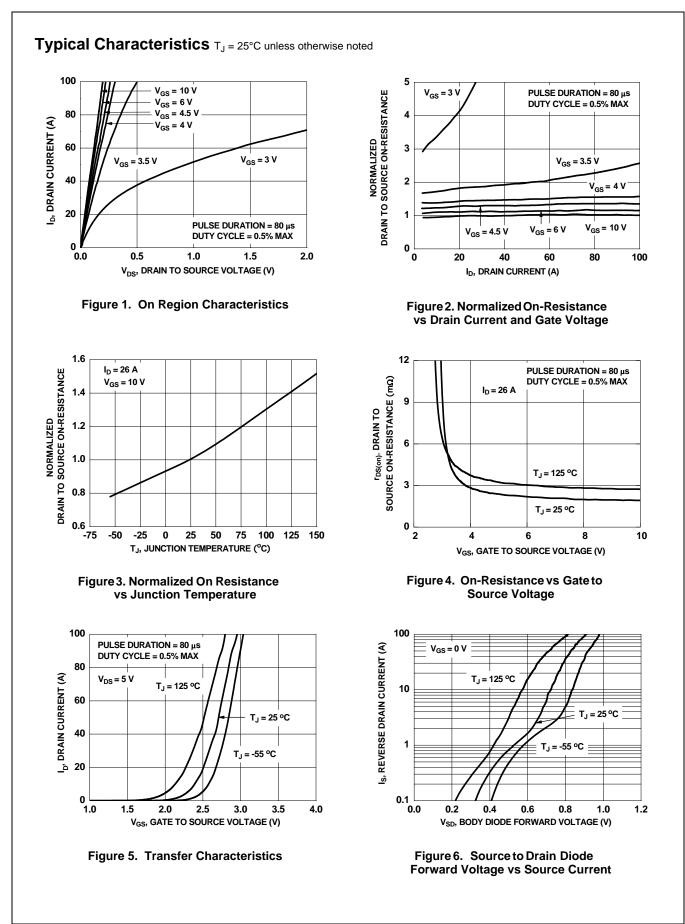
nC



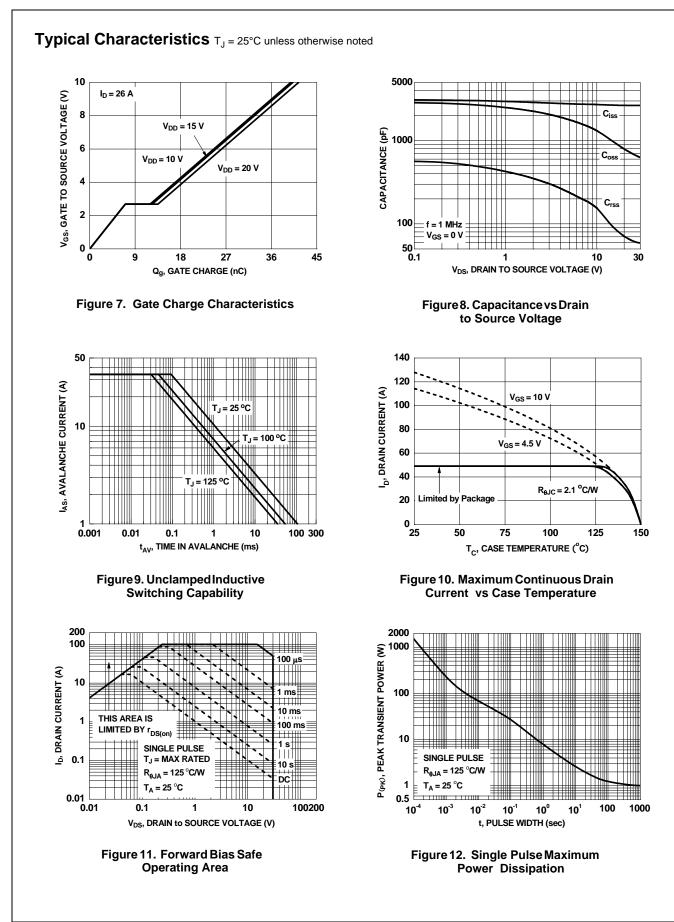
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

3. E\_{AS} of 86  $\,$  mJ is based on starting T\_J = 25  $^{\circ}C,$  L = 0.3 mH, I\_{AS} = 24 A, V\_{DD} = 27 V, V\_{GS} = 10 V.

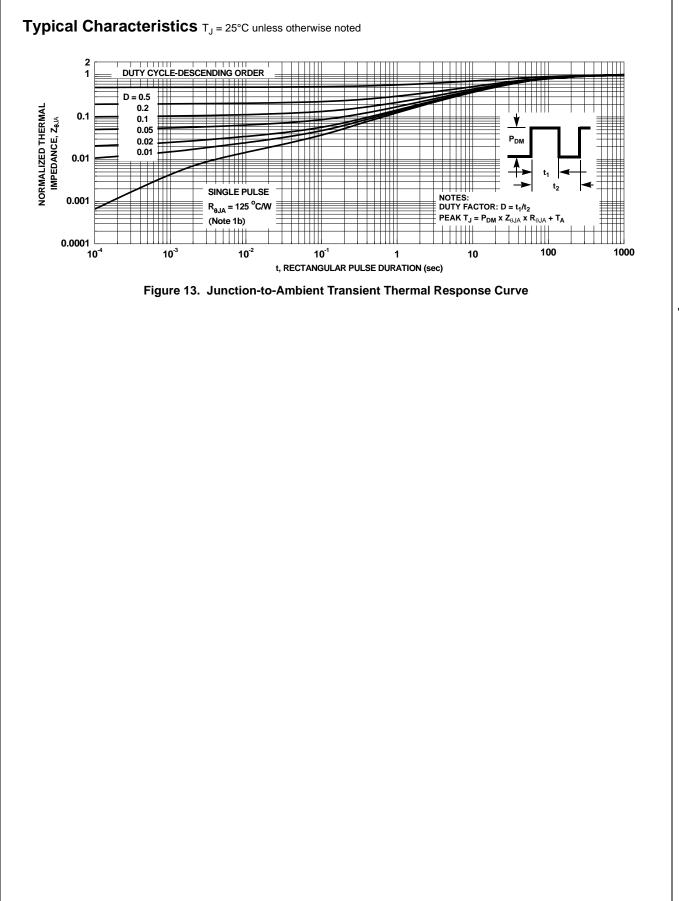
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.







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# Typical Characteristics (continued)

#### SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS8023S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

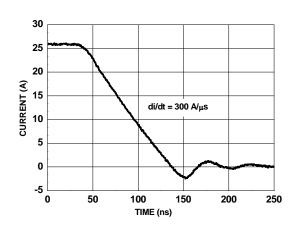
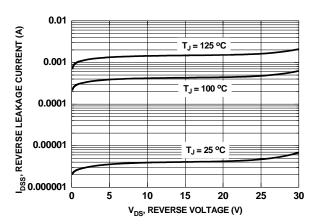
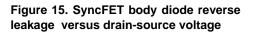


Figure 14. FDMS8023S SyncFET body diode reverse recovery characteristic







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